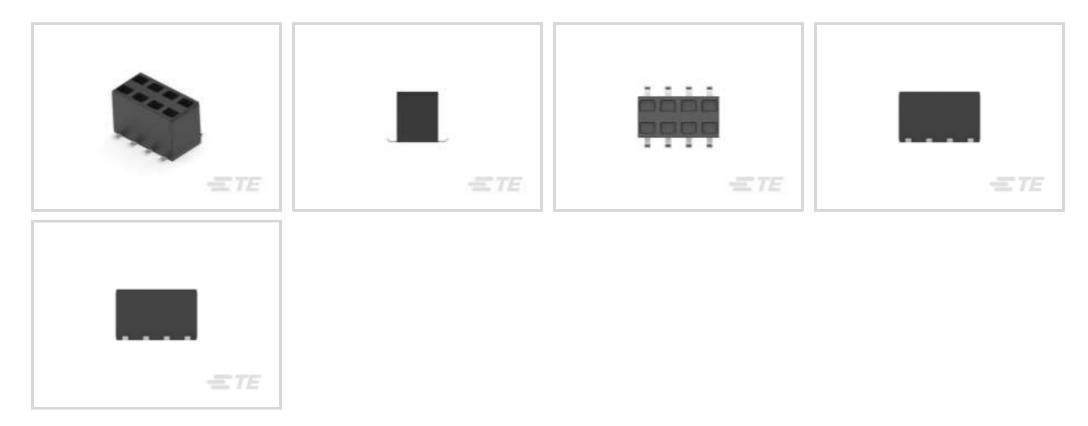
969973-4 ✓ ACTIVE

AMPMODU | AMPMODU HV-100/HV-190

TE Internal #: 969973-4 PCB Mount Receptacle, Vertical, Board-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Gold, Surface Mount, Signal, Black, AMPMODU HV-100/HV-190

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 8

Number of Rows: 2

Features



Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	8
Number of Rows	2
Board-to-Board Configuration	Parallel
Body Features	
Connector Profile	Standard
Primary Product Color	Black
Contact Features	

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Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.5 μm
Contact Layout	Inline
Mating Pin Diameter	.63 mm[.025 in]
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	3 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.7 mm[.027 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Bottom & Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP (Liquid Crystal Polymer)
Dimensions	
Connector Height	6.2 mm[.244 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	9 mm[.354 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	

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Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	600
Packaging Type	Reel
Product Compliance For compliance documentation, visit the product page on TE.com>	
Product Compliance	Compliant
Product Compliance For compliance documentation, visit the product page on TE.com>	Compliant Compliant
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC	Compliant

homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Reflow solder capable to 260°C

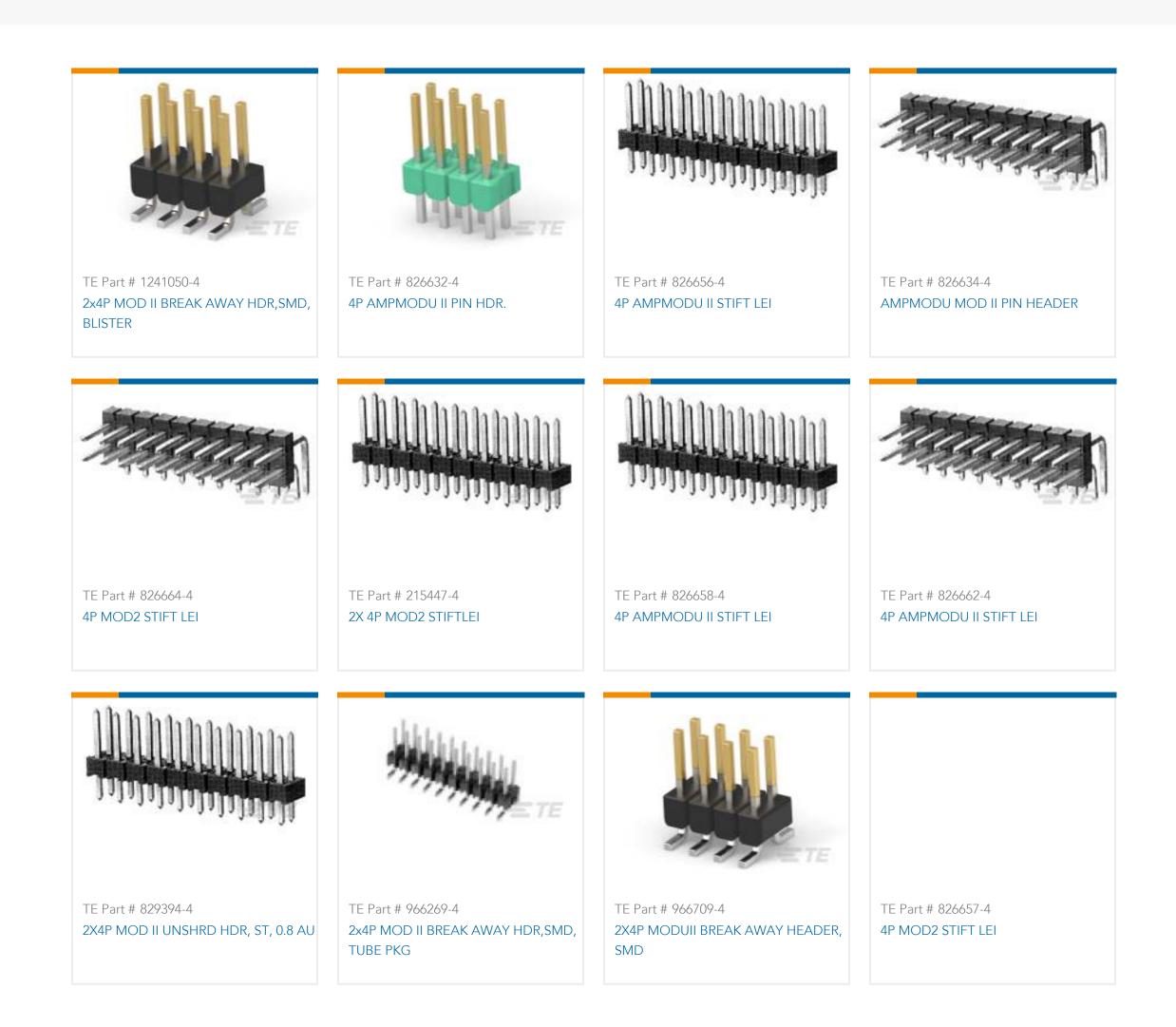
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Receptacle, Vertical, Board-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Gold, Surface Mount, Signal, Black, AMPMODU HV-100/HV-190





Also in the Series AMPMODU HV-100/HV-190



PCB Headers & Receptacles(345)

Customers Also Bought



PCB Mount Receptacle, Vertical, Board-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Gold, Surface Mount, Signal, Black, AMPMODU HV-100/HV-190





Documents

Product Drawings 2x4P HV100 REC. CON, SMD, GOLD, BLISTER

English

CAD Files

Customer View Model ENG_CVM_CVM_969973-4_E.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_969973-4_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_969973-4_E.3d_stp.zip

English

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